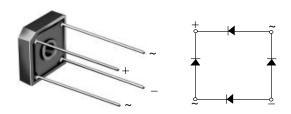


Vishay General Semiconductor

Glass Passivated Single-Phase Bridge Rectifier



Case Style GBPC1

PRIMARY CHARACTERISTICS							
I _{F(AV)} 3 A							
V _{RRM}	50 V to 1000 V						
I _{FSM}	60 A						
I _R	5 μΑ						
V _F	1.0 V						
T _J max.	150 °C						

FEATURES





Typical I_R less than 0.1 μA

· High surge current capability

High case dielectric strength 1500 V_{RMS}

• Solder dip 260 °C, 40 s

 Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



ROHS COMPLIANT

TYPICAL APPLICATIONS

General purpose use in ac-to-dc bridge full wave rectification for switching power supply, home appliances, office equipment, industrial automation applications.

MECHANICAL DATA

Case: GBPC1

Epoxy meets UL 94V-0 flammability rating

Terminals: Silver plated leads, solderable per

J-STD-002 and JESD22-B102 E4 suffix for consumer grade

Polarity: As marked, positive lead by belevled corner **Mounting Torque:** 10 cm-kg (8.8 inches-lbs) max. **Recommended Torque:** 5.7 cm-kg (5 inches-lbs)

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)									
PARAMETER	SYMBOL	GBPC 1005	GBPC 101	GBPC 102	GBPC 104	GBPC 106	GBPC 108	GBPC 110	UNIT
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS bridge input voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
$ \begin{array}{ccc} \text{Maximum average forward} & & & T_{\text{C}} = 60 ^{\circ}\text{C} ^{(1)} \\ \text{rectified output current at} & & & T_{\text{A}} = 25 ^{\circ}\text{C} ^{(2)} \\ \end{array} $	I _{F(AV)}	3.0 2.0			Α				
Peak forward surge current single sine-wave superimposed on rated load	wave I _{FSM} 60		Α						
Rating for fusing (t < 8.3 ms)	l ² t	² t 15		A ² s					
Operating junction and storage temperature range	e T _J , T _{STG} - 55 to + 150			°C					

Notes:

- (1) Unit mounted on 4.0 x 4.0 x 0.11" thick (10.5 x 10.5 x 0.3 cm) aluminum Plate
- (2) Unit mounted on P.C.B. at 0.375" (9.5 mm) lead length with 0.5 x 0.5" (12 x 12 mm) copper pads

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)										
PARAMETER	TEST CONDITIONS	SYMBOL	GBPC 1005	GBPC 101	GBPC 102	GBPC 104	GBPC 106	GBPC 108	GBPC 110	UNIT
Maximum instantaneous forward voltage drop per diode	1.5 A	V _F	1.0						V	
Maximum DC reverse current at rated DC blocking voltage per diode	T _A = 25 °C T _A = 125 °C	I _R	5.0 500						μΑ	
Typical junction capacitance per diode	4.0 V, 1 MHz	СЈ	21						pF	

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)									
PARAMETER	SYMBOL	GBPC 1005	GBPC 101	GBPC 102	GBPC 104	GBPC 106	GBPC 108	GBPC 110	UNIT
Typical thermal resistance (1)	$egin{array}{c} R_{ hetaJA} \ R_{ hetaJC} \end{array}$	12 8.0					°C/W		

Note:

(1) Bolt down on heat-sink with silicone thermal compound between bridge and mounting surface for maximum heat transfer with #6 screw

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g) PREFERRED PACKAGE CODE BASE QUANTITY DELIVERY MODE						
GBPC106-E4/51	2.5	51	100	Paper box			

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

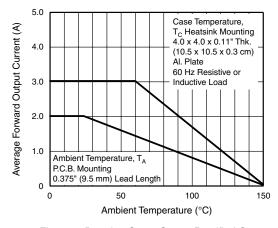


Figure 1. Derating Curve Output Rectified Current

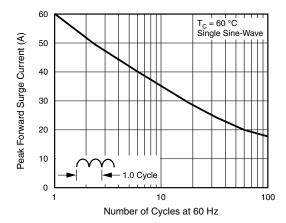


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current Per Diode



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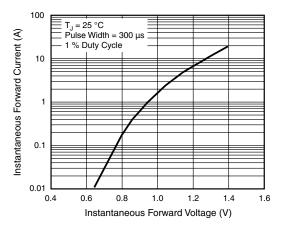


Figure 3. Typical Forward Characteristics Per Diode

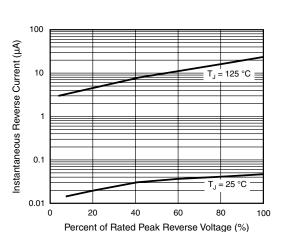


Figure 4. Typical Reverse Leakage Characteristics Per Diode

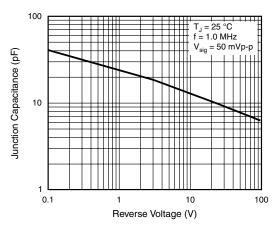


Figure 5. Typical Junction Capacitance Per Diode

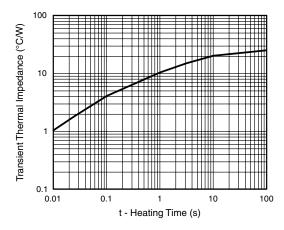
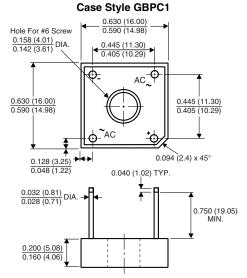


Figure 6. Typical Transient Thermal Impedance Per Diode

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



Polarity shown on side of case: Positive lead by beveled corner



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